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Dimensions	
Chip Size	1210
L	3.2mm +/-0.2mm
W	2.5mm +/-0.2mm
T	1.25mm +/-0.15mm
B	0.5mm +/-0.25mm

Packaging Specifications	
Packaging	Cut Reel
Packaging Quantity	50

General Information	
Series	COG HT 260C
Style	SMD Chip
Description	SMD, MLCC, High Temperature, 260C
Features	High Temperature, Low ESR
RoHS	Yes
Termination	Gold
Marking	No
AEC-Q200	No
Component Weight	40 mg
Miscellaneous	Gold (Au) 30 - 70 micro inches.
Shelf Life	78 Weeks
MSL	1

Specifications	
Capacitance	0.015 uF
Measurement Condition	1kHz 1.0Vrms
Capacitance Tolerance	5%
Voltage DC	25 VDC
Dielectric Withstanding Voltage	62.5 VDC
Temperature Range	-55/+260°C
Temperature Coefficient	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30PPM/C, 1kHz 1.0Vrms
Dissipation Factor	0.1% 1kHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	66.6667 GOhms